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## FDMC610P P-Channel PowerTrench<sup>®</sup> MOSFET -12 V, -80 A, 3.9 mΩ

## **Features**

- Max r<sub>DS(on)</sub> = 3.9 mΩ at V<sub>GS</sub> = -4.5 V, I<sub>D</sub> = -22 A
- Max r<sub>DS(on)</sub> = 6.4 mΩ at V<sub>GS</sub> = -2.5 V, I<sub>D</sub> = -16 A
- State-of-the-art switching performance
- Lower output capacitance, gate resistance, and gate charge boost efficiency
- Shielded gate technology reduces switch node ringing and increases immunity to EMI and cross conduction
- RoHS Compliant

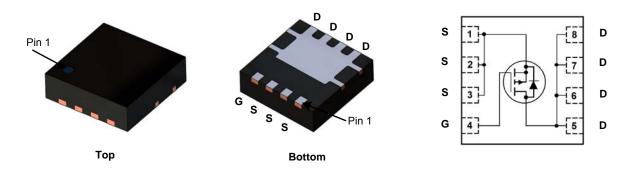


## **General Description**

This P-Channel MOSFET has been designed specifically to improve the overall efficiency and to minimize switch node ringing of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low r<sub>DS(on)</sub>, fast switching speed and body diode reverse recovery performance.

## Applications

- High side switching for high end computing
- High power density DC-DC synchronous buck converter



Power 33

## MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Parameter		Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			-12	V
V <sub>GS</sub>	Gate to Source Voltage			±8	V
	Drain Current - Continuous	T <sub>C</sub> = 25 °C		-80	
I <sub>D</sub>	- Continuous		(Note 1a)	-22	А
	- Pulsed			-200	
C	Power Dissipation	T <sub>C</sub> = 25 °C		48	w
P <sub>D</sub>	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	2.4	vv
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperat	ure Range		-55 to +150	°C

## **Thermal Characteristics**

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	T <sub>C</sub> = 25 °C		2.6	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	T <sub>A</sub> = 25 °C	(Note 1a)	53	C/VV

## **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
23AB	FDMC610P	Power 33	13 "	12 mm	3000 units

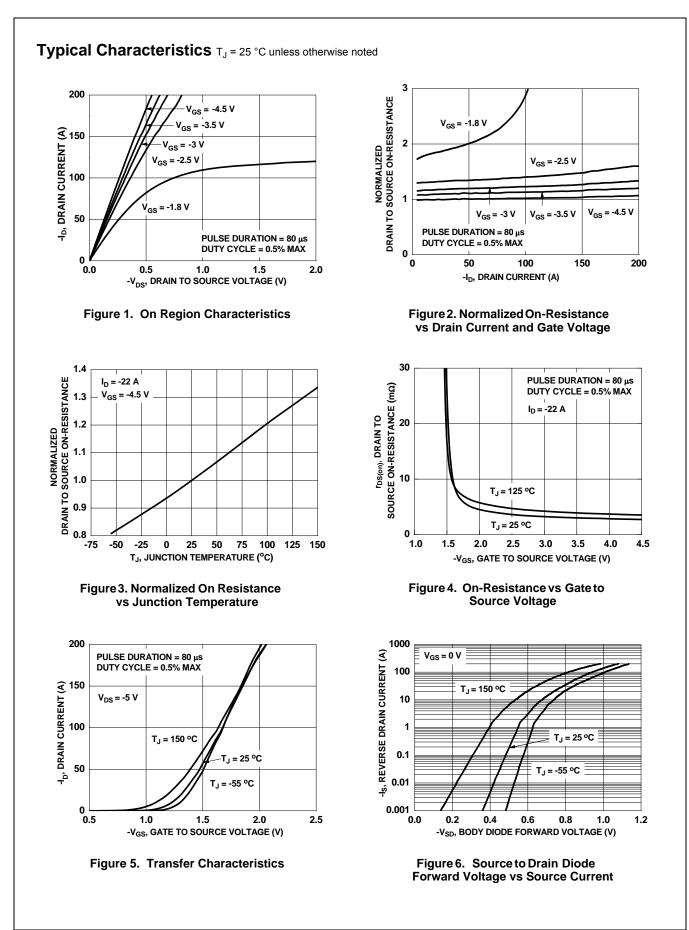
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	acteristics						
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = -250 μA , V <sub>GS</sub> = 0 V	-12			V	
$\Delta BV_{DSS}$ $\Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$ , referenced to 25 °C		-13		mV/°C	
IDSS	Zero Gate Voltage Drain Current	V <sub>DS</sub> = -9.6 V, V <sub>GS</sub> = 0 V			-1	μA	
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS}$ = ±8 V, $V_{DS}$ = 0 V			±100	nA	
On Chara	acteristics						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = -250 μA	-0.4	-0.7	-1	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_{.l}}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$ , referenced to 25 °C		3.1		mV/°C	
Ū	· ·	$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -22 \text{ A}$		2.8	3.9		
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS} = -2.5 \text{ V}, \text{ I}_{D} = -16 \text{ A}$		3.7	6.4	mΩ	
20(01)		$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -22 \text{ A}, \text{T}_{J} = 125 \text{ °C}$		3.6	5.4	-	
9 <sub>FS</sub>	Forward Transconductance	$V_{DD} = -5 V, I_D = -22 A$		16		S	
	Characteristics	1					
C <sub>iss</sub>	Input Capacitance			0.89	1.25	nF	
C <sub>oss</sub>	Output Capacitance	f = 1  MHz		1620	2270	pF	
C <sub>rss</sub>	Reverse Transfer Capacitance		0.1	1440	2015	pF	
R <sub>g</sub>	Gate Resistance		0.1	3.6	7.2	Ω	
Switching	g Characteristics						
t <sub>d(on)</sub>	Turn-On Delay Time			24	39	ns	
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = -6 V, I <sub>D</sub> = -22 A,		37	60	ns	
t <sub>d(off)</sub>	Turn-Off Delay Time	V <sub>GS</sub> = -4.5 V, R <sub>GEN</sub> = 6 Ω		193	309	ns	
t <sub>f</sub>	Fall Time			87	139	ns	
Qg	Total Gate Charge			71	99	nC	
Q <sub>gs</sub>	Gate to Source Charge	− V <sub>DD</sub> = -6 V, I <sub>D</sub> = -22 A, − V <sub>GS</sub> = -4.5 V		13		nC	
Q <sub>gd</sub>	Gate to Drain "Miller" Charge	V <sub>GS</sub> 4.5 V		14		nC	
Drain-So	urce Diode Characteristics						
N/	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = -2 A$ (Note 2)		-0.6	-1.2	V	
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = -22 A$ (Note 2)		-0.8	-1.2	V	
	Reverse Recovery Time	— I <sub>F</sub> = -22 A, di/dt = 100 A/μs		36	58	ns	
t <sub>rr</sub>							

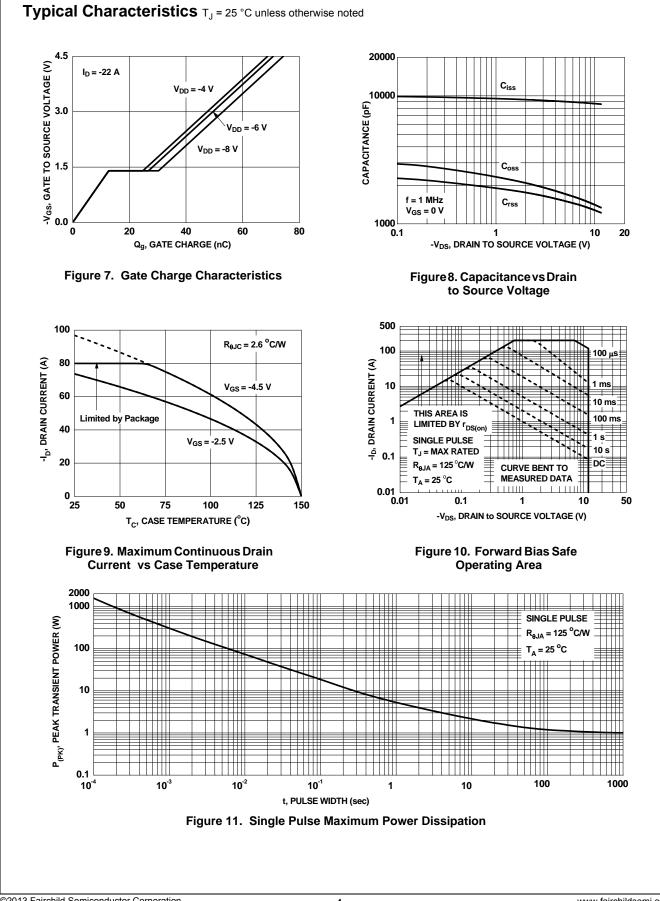
2. Pulse Test: Pulse Width < 300  $\mu s,$  Duty cycle < 2.0%.

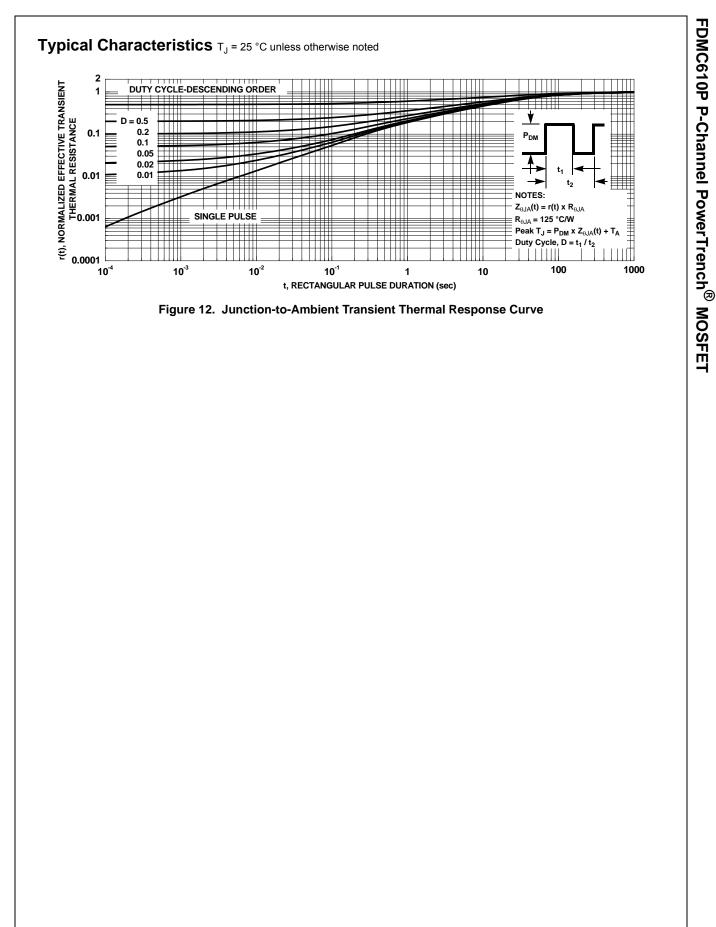
a. 53 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper

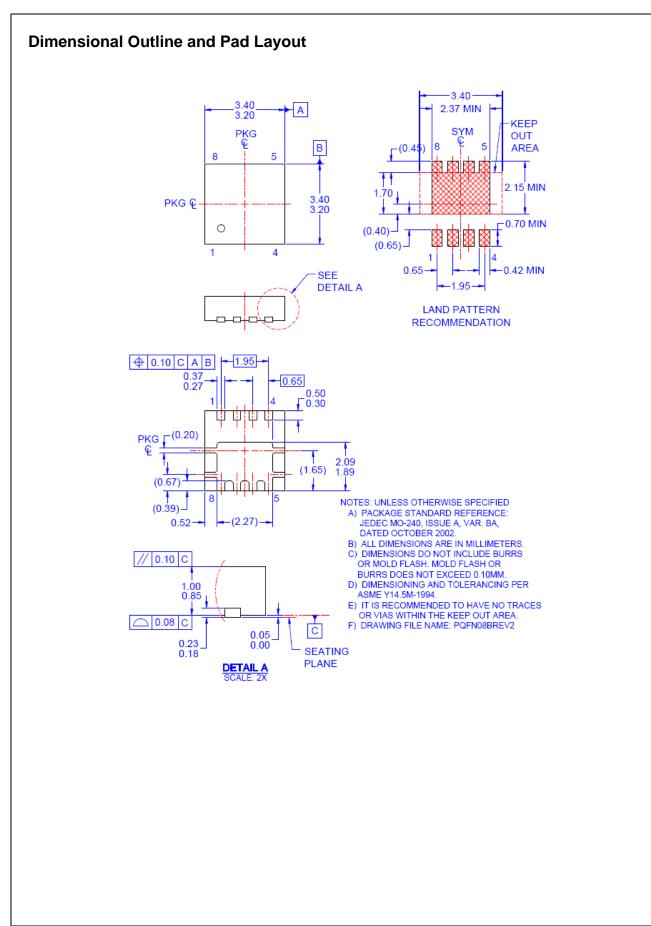


b. 125 °C/W when mounted on a minimum pad of 2 oz copper









FDMC610P P-Channel PowerTrench<sup>®</sup> MOSFET



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